

## EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	13028	((438/106) or (438/108) or (438/120) or (438/129) or (438/612) or (438/613) or (438/637) or (438/780) or (438/781)).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/04/11 13:57
L2	2821	L1 and ((vibrat\$3 or thermal) same (load or process or treat\$4))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/11 13:57
L3	456	L1 and ((vibrat\$3 or ultrasonic) same (load or process or treat\$4))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/11 13:58
L4	95	L1 and ((vibrat\$3 near10 ultrasonic) same (load or process or treat\$4))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/11 13:58
L5	0	4 and (imprint\$3 near10 polymer)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/11 13:58
L6	2	3 and (imprint\$3 near10 polymer)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/11 13:58
S1	379479	("438"/\$.ccls. or "257"/\$.ccls.)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/10 22:55
S2	70	S1 and (imprint\$3 near10 polymer)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/11 13:58

## EAST Search History

S3	1	S2 and (bond near5 pad) and (solder near5 bump)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/02/22 11:47
S4	115	S1 and (imprint\$3 same polymer)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/02/22 11:46
S5	3	S4 and (bond near5 pad) and (solder near5 bump)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/02/22 11:38
S6	644	S1 and (passivation near10 polymer)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/02/22 11:47
S7	75	S6 and (bond near5 pad) and (solder near5 bump)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/02/22 11:47
S8	17	S7 and (cur\$3 near5 (polymer or passivation))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/02/22 11:48
S9	16	S8 and ((imprint\$ or pattern\$3) same (polymer or passivation))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/02/22 12:48
S10	0	S8 and (stamp\$3 same (polymer or passivation))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/02/22 12:48

## EAST Search History

S11	12	((("6897089") or ("20050106855") or ("6756294") or ("20040142575") or ("20040256734") or ("20040207081")).PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/04/10 22:56
S12	2	S11 and ((vibrat\$3 or thermal) same (load or process or treat\$4))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/10 22:59
S13	13028	((438/106) or (438/108) or (438/120) or (438/129) or (438/612) or (438/613) or (438/637) or (438/780) or (438/781)).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/04/11 00:21
S14	2821	S13 and ((vibrat\$3 or thermal) same (load or process or treat\$4))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/11 13:57
S15	6	S14 and ((stamp\$3 or imprint\$3) near10 polymer)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/11 00:39
S16	1	S15 and (pad or (bond adj pad))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/11 00:40
S17	1	S15 and solder\$3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/11 00:40